

AMENDMENT UNDER 37 C.F.R. § 1.116  
EXPEDITING PROCEDURE  
EXAMINING GROUP 1700

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant:	Luetzen, <i>et al.</i>	Docket No.:	INF 2004 SP 00115 US
Serial No.:	10/721,225	Art Unit:	1792
Filed:	November 26, 2003	Examiner:	George A. Goudreau
		Conf. No.:	5694
For:	Method and Structures for Increasing the Structure Density and the Storage Capacitance in a Semiconductor Wafer		

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT UNDER 37 CFR § 1.116**

Dear Sir:

Applicant respectfully submits the following amendments and remarks in response to Examiner's Office Action dated April 29, 2008, which Action is made final. Applicant respectfully requests that these amendments and remarks be entered in pursuant to the provisions of 37 CFR § 1.116, and respectfully request reconsideration of the claims.